

# PMEG045T150EPD

45 V, 15 A low VF Trench MEGA Schottky barrier rectifier

2 September 2015

Product data sheet

## 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier, encapsulated in a CFP15 (SOT1289) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 15 A
- Reverse voltage: V<sub>R</sub> ≤ 45 V
- Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.78 mm
- AEC-Q101 qualified

## 3. Applications

- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- Low power consumption application

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 145 °C; square wave	-	-	15	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	45	V
V <sub>F</sub>	forward voltage	$I_F$ = 15 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	480	550	mV
I <sub>R</sub>	reverse current	$V_R = 10 \text{ V; } t_p \le 3 \text{ ms; } \delta \le 0.03;$ $T_j = 25 \text{ °C; pulsed}$	-	16	50	μA
		$V_R = 45 \text{ V; } t_p \le 3 \text{ ms; } \delta \le 0.03;$ $T_j = 25 \text{ °C; pulsed}$	-	30	100	μΑ



## 5. Pinning information

#### Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		K PA
2	Α	anode	3	aaa-009063
3	K	cathode	2	
			CFP15 (SOT1289)	

## 6. Ordering information

#### Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PMEG045T150EPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289			

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG045T150EPD	045T 150E

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
I <sub>F</sub>	forward current	T <sub>sp</sub> = 140 °C; δ = 1		-	21	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 145 °C; square wave		-	15	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	210	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
			[3]	-	3.5	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

#### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance	[1][	[1][2]	-	-	90	K/W
	_		[1][3]	-	-	70	K/W
	ambient		[1][4]	-	-	42	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

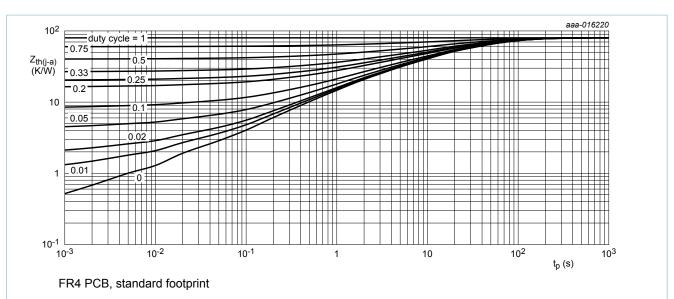


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

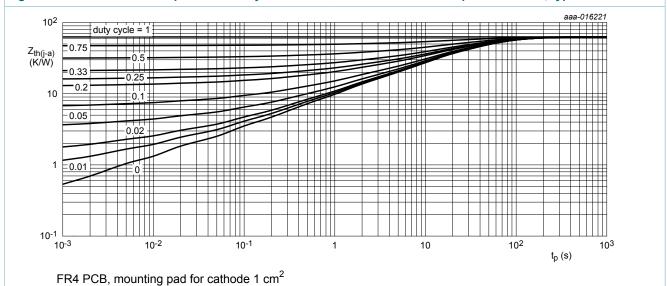
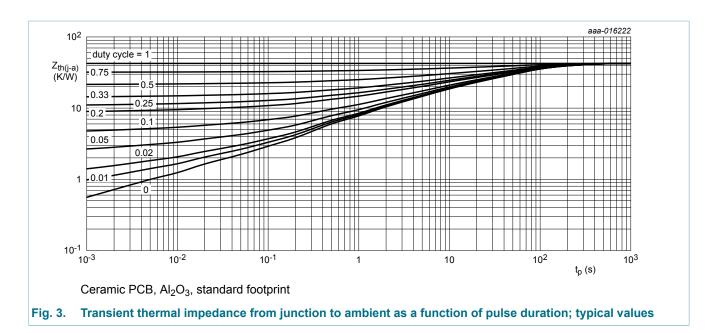


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

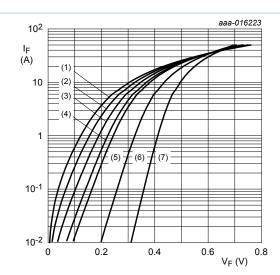


## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R$ = 5 mA; $T_j$ = 25 °C; $t_p$ ≤ 1.2 ms; $\delta$ ≤ 0.12; pulsed	45	-	-	V
V <sub>F</sub>	forward voltage	$I_F$ = 1 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	320	380	mV
		$I_F$ = 5 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	390	460	mV
		$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	440	-	mV
		$I_F$ = 15 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	480	550	mV
		$I_F$ = 15 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 125 °C; pulsed	-	405	-	mV
I <sub>R</sub>	reverse current	$V_R = 5 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.03;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	12	-	μA
		$V_R = 10 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.03;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	16	50	μΑ
		$V_R = 45 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.03;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	30	100	μΑ
		$V_R = 45 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.03;$ $T_j = 125 \text{ °C}; \text{ pulsed}$	-	22	-	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	2200	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	800	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$	-	60	-	ns
t <sub>rr</sub>	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}; I_F = 6 \text{ A};$ $V_R = 26 \text{ V}$	-	20	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 °\text{C}$	-	305	-	mV

6/15



pulsed condition

(1)  $T_i = 175 \,^{\circ}C$ 

(2)  $T_i = 150 \, ^{\circ}C$ 

(3)  $T_i = 125 \, ^{\circ}C$ 

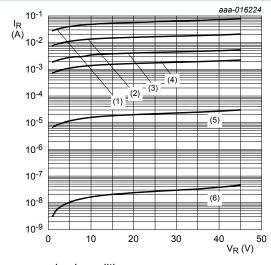
(4)  $T_j = 100 \, ^{\circ}C$ 

(5)  $T_j = 85 \,^{\circ}C$ 

(6)  $T_j = 25 \,^{\circ}C$ 

(7)  $T_j = -40 \, ^{\circ}\text{C}$ 

Fig. 4. Forward current as a function of forward voltage; typical values



pulsed condition

(1)  $T_i = 150 \, ^{\circ}C$ 

(2)  $T_i = 125 \, ^{\circ}C$ 

(3)  $T_i = 100 \,^{\circ}\text{C}$ 

(4)  $T_i = 85 \,^{\circ}C$ 

(5) T<sub>j</sub> = 25 °C

(6)  $T_i = -40 \, ^{\circ}C$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values

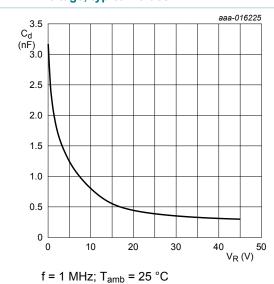
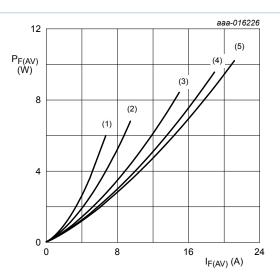


Fig. 6. Diode capacitance as a function of reverse voltage; typical values



T<sub>i</sub> = 100 °C

 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

 $(3) \delta = 0.5$ 

 $(4) \delta = 0.8$ 

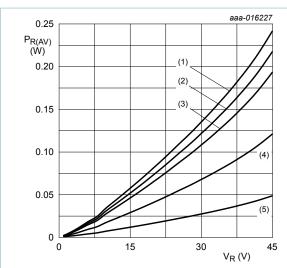
 $(5) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

PMEG045T150EPD

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T<sub>i</sub> = 100 °C

, (1) δ = 1

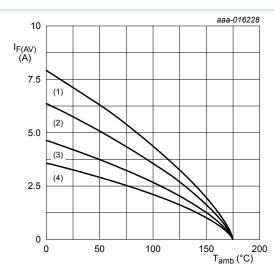
 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$ 

 $(4) \delta = 0.5$ 

 $(5) \delta = 0.2$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C

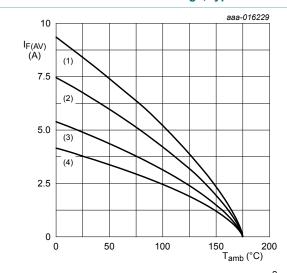
(1)  $\delta$  = 1; DC

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 175 °C

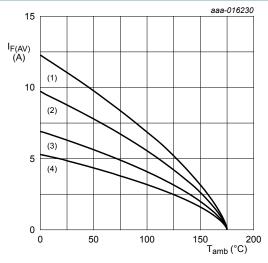
(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 175 °C

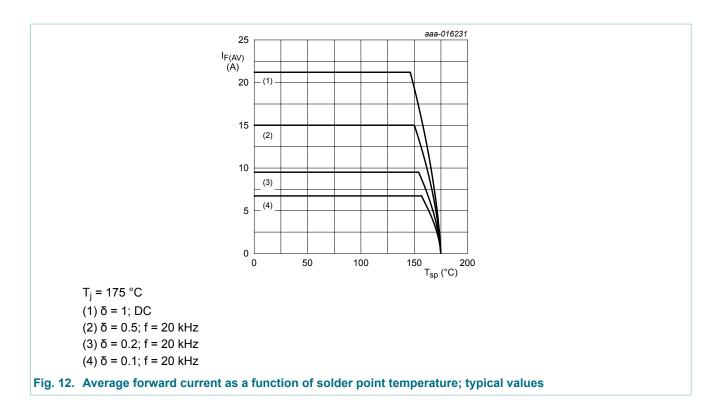
(1)  $\delta$  = 1; DC

(2)  $\delta$  = 0.5; f = 20 kHz

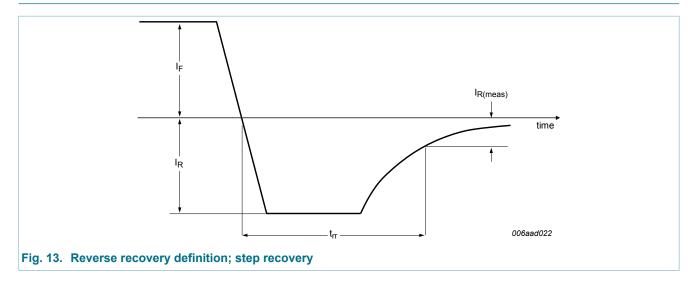
(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

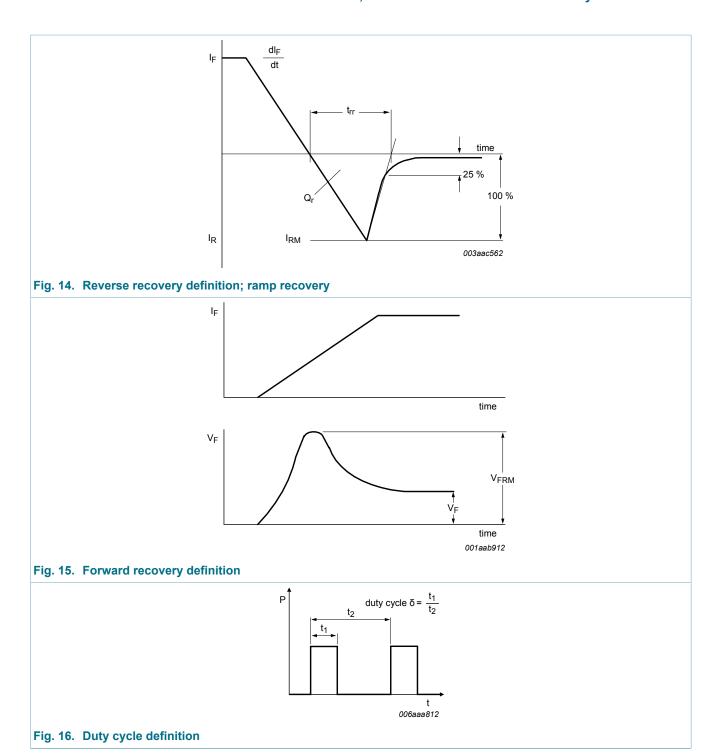
Fig. 11. Average forward current as a function of ambient temperature; typical values



### 11. Test information



9/15

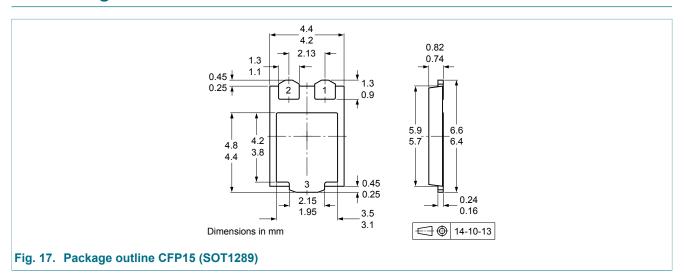


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

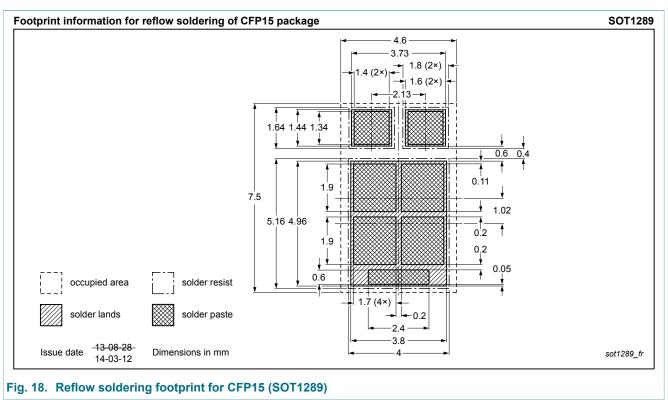
### 11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



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## 14. Revision history

#### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG045T150EPD v.1	20150902	Product data sheet	-	-

### 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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### 16. Contents

1	General description	1
2	Features and benefits	1
3	Applications	1
4	Quick reference data	1
5	Pinning information	2
6	Ordering information	2
7	Marking	2
8	Limiting values	3
9	Thermal characteristics	3
10	Characteristics	6
11	Test information	9
11.1	Quality information	11
12	Package outline	11
13	Soldering	11
14	Revision history	12
15	Legal information	13
15.1	Data sheet status	13
15.2	Definitions	13
15.3	Disclaimers	13
15.4	Trademarks	14

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